10	o the Honorable Commissioner of F 102128	186 attached original documents or copy thereof.
1	Name of conveying party(ies):6 - 1-02Li-Chih ChenChia-Tsun HsuChia-Fu LinKuo-Ching LeeYen-Ming ChenKai-Ming ChingHsin-Hui LeeChao-Yuan Su	 Name and address of receiving party(ies): Taiwan Semiconductor Manufacturing Co. Landon No. 121 Park Avenue 3 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.
3	Nature of conveyance: Assignment I Merger Security Agreement Change of Name Other: Execution Date: March 29, 2002	Additional name(s) & address(es) attached □ Yes ⊠ No
4	Application number(s) or patent number(s):	on, the execution date of the application is: <u>03-29-02</u>
5	Additional numbers a Name and address of party to whom correspondence concerning document should be mailed:	attached? □ Yes ⊠ No 6 Total number of applications and patents involved: <u>1</u>
	RANDY W. TUNG Tung & Associates 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302	 7 Total fee (37 CFR 3.41) \$40.00 □ Enclosed ⊠ Authorized to charge credit card (w/filing fee) 8 Deposit Account Number: 50-0484 (Attach duplicate copy of this page if paying by deposit account)
200 581		E THIS SPACE
9	Statement and signature. To the best of my knowledge and belief, the foregoing inform the original document.	mation is true and correct and any attached copy is a true copy of May 28, 2002

PATENT REEL: 012988 FRAME: 0983

ASSIGNMENT

WHEREAS, we, <u>LI-CHIH CHEN, CHIA-TSUN HSU, CHIA-FU LIN, KUO-CHING</u> <u>LEE, YEN-MING CHEN, KAI-MING CHING, HSIN HUI LEE and CHAO-YUAN SU</u>, have invented certain improvements in

DFR LAMINATING AND FILM REMOVING SYSTEM

for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we, <u>LI-CHIH CHEN, CHIA-</u><u>TSUN HSU, CHIA-FU LIN, KUO-CHING LEE, YEN-MING CHEN, KAI-MING CHING, HSIN</u><u>HUI LEE and CHAO-YUAN SU</u>, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the $\underline{-9th}$ day of \underline{Maych} , 2002, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any

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Letters Patent that may be granted in pursuance of said application and any divisional, continuation or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

1.1. chih chen

LI-CHIH CHEN

<u>chia-Fu</u> Lin CHIA-FU LIN

Yen-Ming Chen

YEN-MING CHEN

Kin Hui Lee HSIN-HUI LEF

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302 CHIA- TSUN HSU

Kuo-ching Lee

Kai-Ming Ching KAI-MING CHING

Chao-Juan Sur CHAO-YUAN SU

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RECORDED: 06/01/2002